



Product Change Notification

111420 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 111420 - 00

**Change Title: Intel Battery Backup
AXXRSBBU9, PCN 111420-00,
Product Material, Product
Material, Additional cables added
to BBU9 to support Romley
Systems and RAID Modules**

Date of Publication: March 30, 2012

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	May 30, 2012
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Description of Change to the Customer:

- 1) Adding 4 additional cables to Product for Romley Systems and Romley RAID modules support
- 2) Also adding a cable tie wrap and updating the IATA label

Customer Impact of Change and Recommended Action:

Intel anticipates no customer impact for these changes.

Products Affected / Intel Ordering Codes:

Marketing Name	Pre Conversion Product Code	Pre Conversion MM#	Post Conversion Product Code	Post Conversion MM#
Intel® RAID Smart Battery AXXRSBBU9, Sin	AXXRSBBU9	914238	AXXRSBBU9	919738

PCN Revision History:

Date of Revision:
March 30, 2012

Revision Number:
00

Reason:
Originally Published PCN